# **MDXM SERIES**

# MINIATURE SINGLE-PHASE BRIDGE RECTIFIER

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# **MD1M THRU MD7M**

### MINIATURE GLASS PASSIVATED SINGLE-PHASE BRIDGE RECTIFIER



REVERSE VOLTAGE: 50 to 1000 VOLTS FORWARD CURRENT: 0.5 AMPERE

#### **FEATURES**

· Glass passivated chip junction

· Low forward voltage drop

· High surge overload rating of 30 Amperes peak

· Ideal for printed circuit board

 $\cdot$  High temperature soldering guaranteed:

260°C for 10 seconds

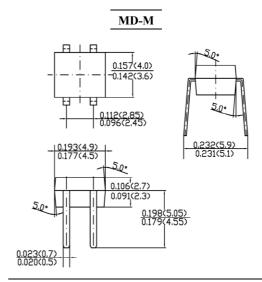
### **MECHANICAL DATA**

Case: Molded plastic, MD-M

Epoxy: UL 94V-O rate flame retardant

Terminals: Leads solderable per MIL-STD-202,

method 208 guaranteed Mounting position: Any Weight: 0.008ounce, 0.22gram



**Dimensions in inches and (millimeters)** 

# Maximum Ratings and Electrical Characteristics

Ratings at 25 ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

	Symbols	MD1M	MD2M	MD3M	MD4M	MD5M	MD6M	MD7M	Units
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	$V_{RMS}$	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current			•	•	•	•	•	•	
(see Fig. 1) on glass-epoxy P.C.B (Note 2)	$I_{(AV)}$ 0.5								Amp
on aluminum substrate (Note 3)	0.8								
Peak Forward Surge Current,									
8.3ms single half-sine-wave	$I_{FSM}$	30							Amp
superimposed on rated load (JEDEC method)									
Maximum Forward Voltage	V	1.0							Volts
at 0.4A DC and 25	$V_{\mathrm{F}}$								
Maximum Reverse Current at T <sub>A</sub> =25	т	5.0 500							uAmp
at Rated DC Blocking Voltage T <sub>A</sub> =125	$I_R$								
Typical Junction Capacitance (Note 1)	C <sub>J</sub>				13				pF
Typical Thermal Resistance (Note 3)	$R_{\theta JA}$				70				/W
Typical Thermal Resistance (Note 2)	$R_{\theta JL}$				20				/W
Operating and Storage Temperature Range	T <sub>J</sub> , Tstg				-55 to +15	0			

#### NOTES:

- 1- Measured at 1  $\ensuremath{\text{MH}_{\text{Z}}}$  and applied reverse voltage of 4.0 VDC.
- 2- On glass epoxy P.C.B. mounted on 0.05 x 0.05" (1.3 x 1.3mm) pads
- 3- On aluminum substrate P.C.B. with an area of 0.8" x 0.8" (20 x 20mm) mounted on 0.05 x 0.05" (1.3 x 1.3mm) solder pad



## RATINGS AND CHARACTERISTIC CURVES

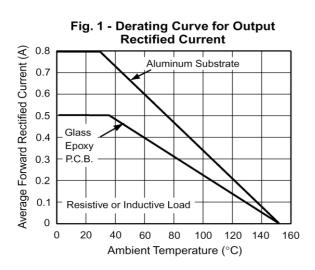


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current Per Leg 35 Peak Forward Surge Current (A) T<sub>A</sub> = 40°C 30 Single Half Sine-Wave (JEDEC Method) 25 f = 60 Hz 20 f = 50 Hz 15 10 5.0 0 100 10 Number of Cycles

Fig. 3 - Typical Forward Voltage Characteristics Per Leg 10 Instantaneous Forward Current (A) T<sub>J</sub> = 150°C T<sub>J</sub> = 25°C Pulse Width = 300μs 1% Duty Cycle 0.4 1.4 0.2 0.6 0.8 1.0 1.2 Instantaneous Forward Voltage (V)

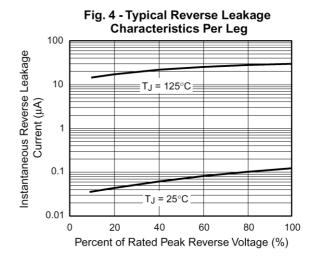


Fig. 5 - Typical Junction Capactitance Per Leg 30 T<sub>J</sub> = 25°C Junction Capacitance (pF) 25 f = 1 MHzVsig = 50mVp-p 20 15 10 5.0 0 100 200 0.1 10 Reverse Voltage (V)